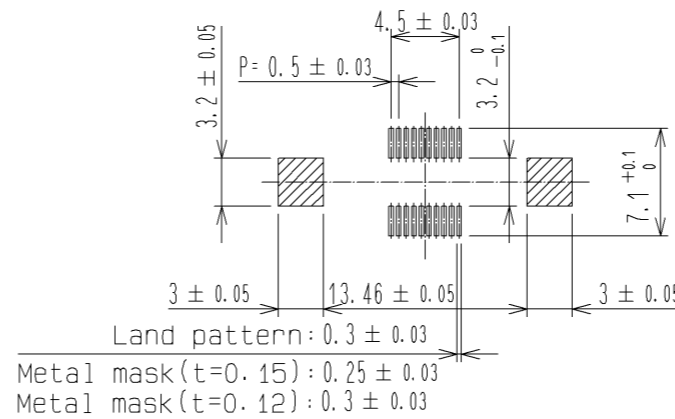
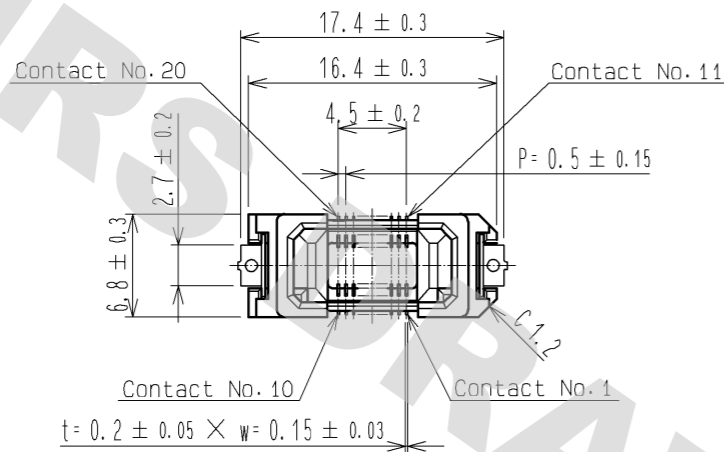
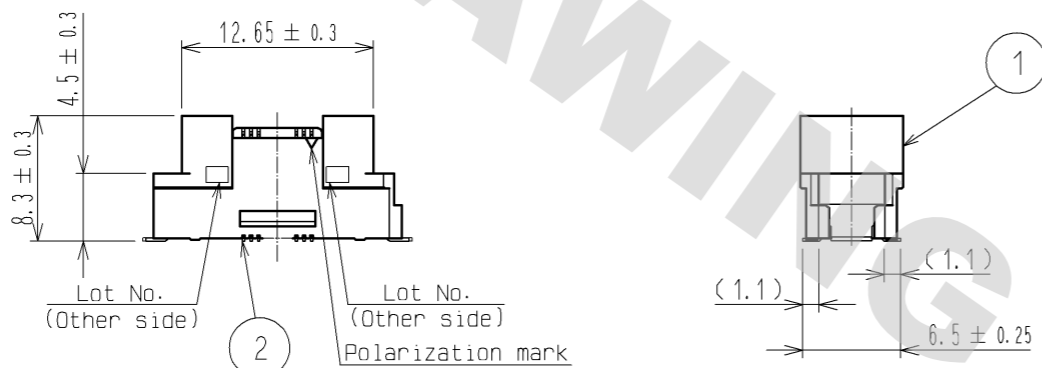


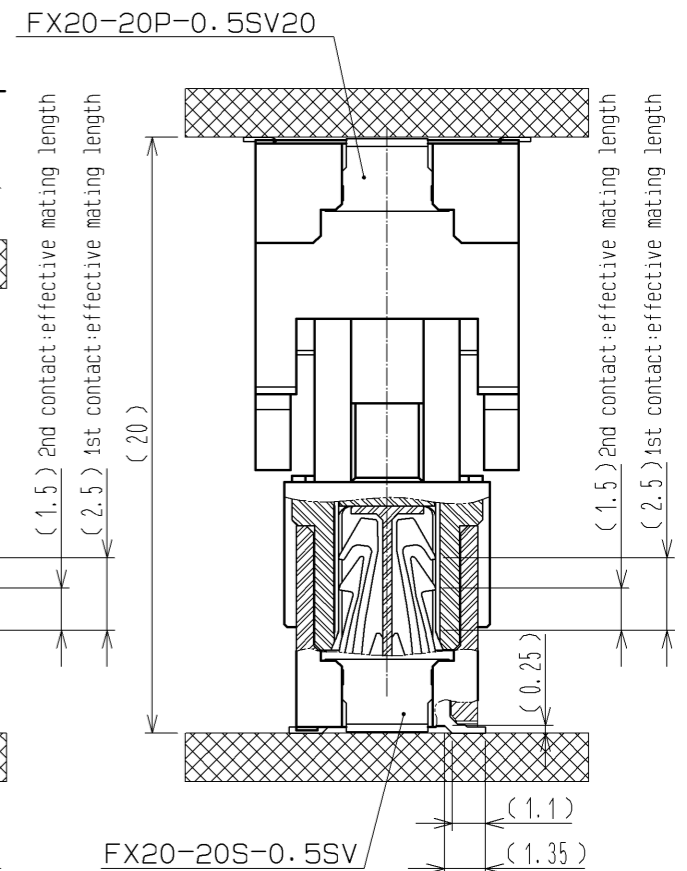
Recommended land pattern dimension of PCB



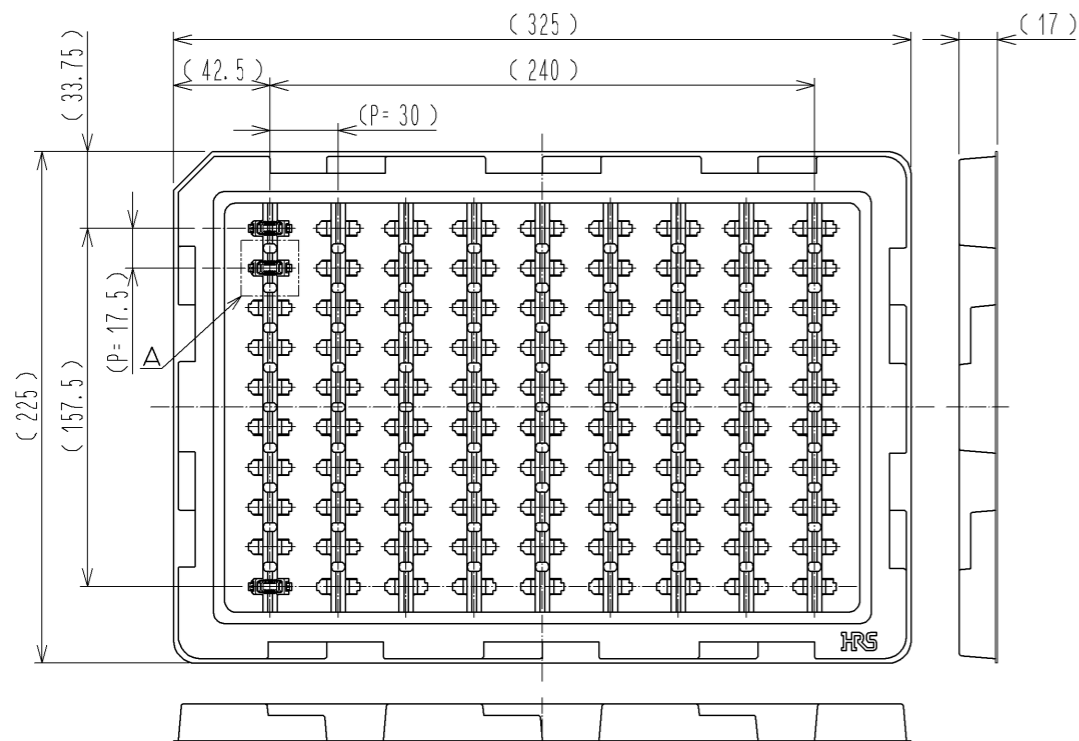
Drawing for mating (No scale)



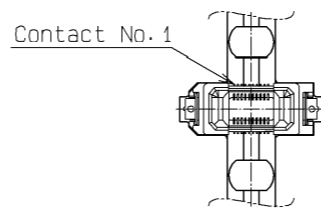
Drawing for mating (No scale)



2 Drawing for packing (No scale)



Δ (1 : 1)



- 1 Lead CO-Planarity is 0.1mm MAX.
- 2 This is packaged in tray. (90pcs/tray)
- 3 Blemish and hit mark can be occurred through out the manufacturing process which doesn't affect quality level.
- 4 Please note that excessive wrenching force could damage this connector. Please refer to the guideline for detailed regulations of the mating method.
- 5 The dimensions in parentheses are for references.

1	LCP	BLACK	UL94V-0	3	BRASS	TIN-PLATING 1 μm			
				2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1 μm			
						LEAD AREA: GOLD 0.03 μm			
						UNDER PLATING: NICKEL 1 μm			
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS	⊕	SCALE	COUNT	DESCRIPTION OF REVISIONS			DESIGNED	CHECKED	DATE
mm		2 : 1	Δ						
APPROVED : HS. OKAWA				13.10.07	DRAWING NO.		EDC3-349947-00		
CHECKED : KI. HIROKAWA				13.10.07	PART NO.		FX20-20S-0.5SV		
DESIGNED : TS. OONO				13.10.07	CODE NO.		CL570-1114-7-00		
DRAWN : TS. OONO				13.10.07					

DRAWING FOR REFERENCE: This is subject to change without notice 12/05/2013